

Features

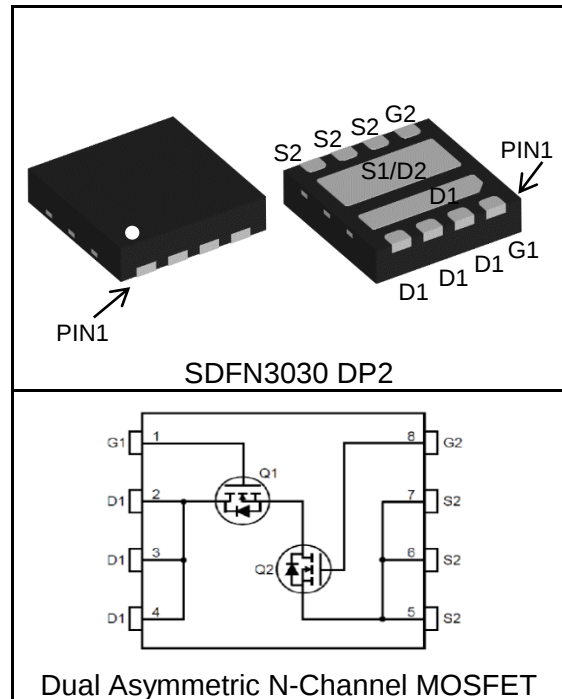
- Q1-Channel
30V/26A,
 $R_{DS(ON)} = 8m\Omega(Typ.) @ V_{GS}=10V$
 $R_{DS(ON)} = 12m\Omega(Typ.) @ V_{GS}=4.5V$
- Q2-Channel
30V/32A,
 $R_{DS(ON)} = 6m\Omega(Typ.) @ V_{GS}=10V$
 $R_{DS(ON)} = 9m\Omega(Typ.) @ V_{GS}=4.5V$
- Excellent $Q_G \times R_{DS(on)}$ product(FOM)
- SGT Technology

Applications

- DC/DC Converter



Pin Description



Absolute Maximum Ratings

Symbol	Parameter		Q1	Q2	Unit
Common Ratings (T _A =25°C Unless Otherwise Noted)					
V _{DSS}	Drain-Source Voltage		30	30	V
V _{GSS}	Gate-Source Voltage		±20	±20	
T _J	Maximum Junction Temperature		150	150	°C
T _{STG}	Storage Temperature Range		-55 to 150	-55 to 150	°C
I _S	Diode Continuous Forward Current	T _C =25°C	26	32	A
Mounted on Large Heat Sink					
I _{DP} ^①	300μs Pulse Drain Current Tested	T _C =25°C	104	128	A
I _D ^②	Continuous Drain Current@T _C (V _{GS} =±10V)	T _C =25°C	26	32	A
		T _C =100°C	16	20	
	Continuous Drain Current@T _A (V _{GS} =±10V) ^③	T _A =25°C	11	12	
		T _A =70°C	9	10	
P _D	Maximum Power Dissipation@T _C	T _C =25°C	16	19	W
		T _C =100°C	6	8	
	Maximum Power Dissipation@T _A ^③	T _A =25°C	2.8	2.8	
		T _A =70°C	1.8	1.8	
R _{θJC}	Thermal Resistance-Junction to Case		8	6.5	°C/W
R _{θJA} ^③	Thermal Resistance-Junction to Ambient		45	45	°C/W
Drain-Source Avalanche Ratings					
E _{AS} ^④	Avalanche Energy, Single Pulsed		9	16	mJ

Electrical Characteristics ($T_A=25^{\circ}\text{C}$ Unless Otherwise Noted)

Symbol	Parameter	Test Condition	KS3428UA3T			Unit		
			Min.	Typ.	Max.			
Static Characteristics								
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _{DS} =250μA	Q1	30			V	
		V _{GS} =0V, I _{DS} =250μA	Q2	30				
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =30V, V _{GS} =0V	Q1			1	μA	
				T _J =125°C				30
		V _{DS} =30V, V _{GS} =0V	Q2			1		
				T _J =125°C				30
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _{DS} =250μA	Q1	1.2	1.7	2.2	V	
		V _{DS} =V _{GS} , I _{DS} =250μA	Q2	1.2	1.7	2.2		
I _{GSS}	Gate Leakage Current	V _{GS} =±20V, V _{DS} =0V	Q1			±100	nA	
		V _{GS} =±20V, V _{DS} =0V	Q2			±100		
R _{DS(ON)} ^⑤	Drain-Source On-state Resistance	V _{GS} =10V, I _{DS} =13A	Q1		8	10	mΩ	
		V _{GS} =10V, I _{DS} =15A	Q2		6	8		
		V _{GS} =4.5V, I _{DS} =10A	Q1		12	16		
		V _{GS} =4.5V, I _{DS} =10A	Q2		9	12		
Diode Characteristics								
V _{SD} ^⑤	Diode Forward Voltage	I _{SD} =13A, V _{GS} =0V	Q1		0.86	1.2	V	
		I _{SD} =15A, V _{GS} =0V	Q2		0.88	1.2		
t _{rr}	Reverse Recovery Time	Q1-Channel I _{SD} =13A, dI _{SD} /dt=100A/μs	Q1		9		ns	
			Q2		12			
Q _{rr}	Reverse Recovery Charge		Q2-Channel I _{SD} =15A, dI _{SD} /dt=100A/μs	Q1		14		nC
				Q2		17		
Dynamic Characteristics ^⑥								
R _G	Gate Resistance	V _{GS} =0V,V _{DS} =0V,F=1MHz	Q`		1.1		Ω	
			Q2		1.2			
C _{iss}	Input Capacitance	Q1-Channel V _{GS} =0V,V _{DS} =15V, Frequency=1.0MHz	Q1		560		pF	
			Q2		690			
C _{oss}	Output Capacitance		Q1		275			
			Q2		330			
C _{rss}	Reverse Transfer Capacitance	Q2-Channel V _{GS} =0V,V _{DS} =15V, Frequency=1.0MHz	Q1		25			
			Q2		35			

Electrical Characteristics ($T_A=25^{\circ}\text{C}$ Unless Otherwise Noted)

Symbol	Parameter	Test Condition	KS3428UA3T			Unit	
			Min.	Typ.	Max.		
Dynamic Characteristics ^⑥							
t _{d(ON)}	Turn-on Delay Time	Q1-Channel V _{DD} =15V, I _{DS} =13A, V _{GEN} =10V, R _G =3Ω	Q1		5		ns
t _r	Turn-on Rise Time		Q2		6		
			Q1		4		
t _{d(OFF)}	Turn-off Delay Time		Q2		8		
		Q1		19			
t _f	Turn-off Fall Time	Q2		23			
		Q1		4			
		Q2		7			
Gate Charge Characteristics ^⑥							
Q _g	Total Gate Charge	Q1-Channel V _{DS} =15V, V _{GS} =10V, I _{DS} =13A	Q1		4.5		nC
Q _{gs}	Gate-Source Charge		Q2		7.1		
		Q1		2.4			
	Q2		2.2				
	Q _{gd}	Gate-Drain Charge	Q1		1.6		
Q2				3.1			

Notes:

- ① Pulse width limited by safe operating area.
- ② Calculated continuous current based on maximum allowable junction temperature.
- ③ When mounted on 1 inch square copper board, $t \leq 10\text{sec}$. The value in any given application depends on the user's specific board design.
- ④ Limited by T_{Jmax} . Starting $T_J = 25^{\circ}\text{C}$, Q1 Channel: $L = 0.5\text{mH}$, $R_G = 25\Omega$, $I_{AS} = 6\text{A}$, $V_{GS} = 10\text{V}$, Q2-Channel: $L = 0.5\text{mH}$, $R_G = 25\Omega$, $I_{AS} = 8\text{A}$, $V_{GS} = 10\text{V}$, Part not recommended for use above this value.
- ⑤ Pulse test; Pulse width $\leq 300\mu\text{s}$, duty cycle $\leq 2\%$.
- ⑥ Guaranteed by design, not subject to production testing.

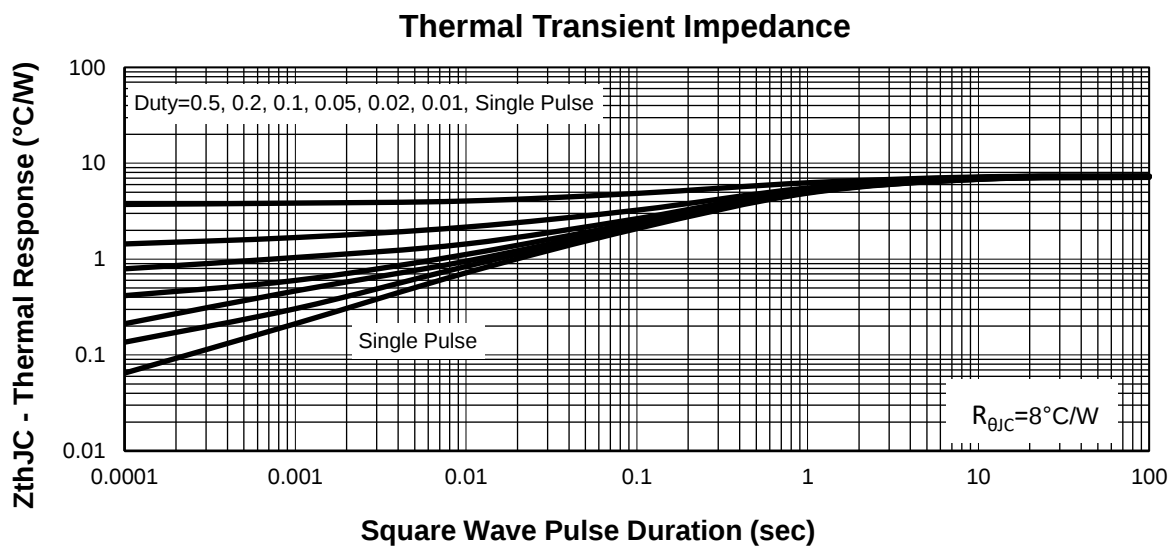
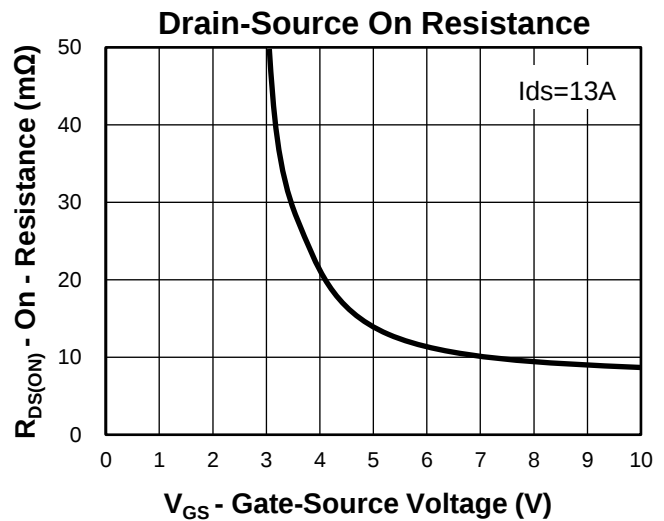
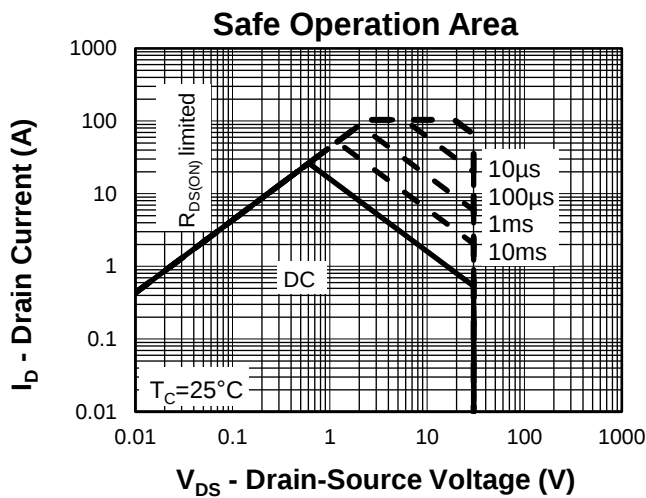
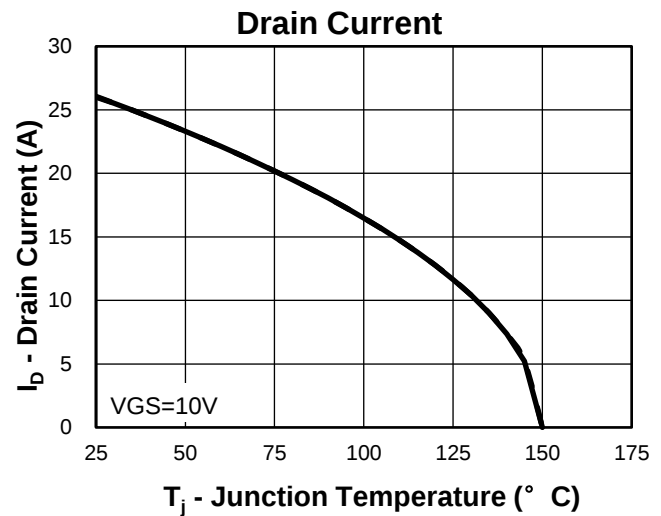
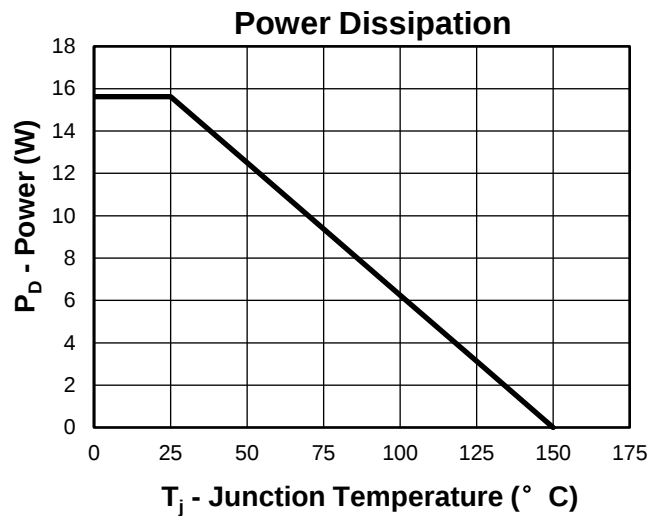
Ordering and Marking Information

Device	Package	Packaging	Quantity	Reel Size	Tape width
KS3428UA3T	SDFN3030 DP2	Tape&Reel	5000	13"	12mm

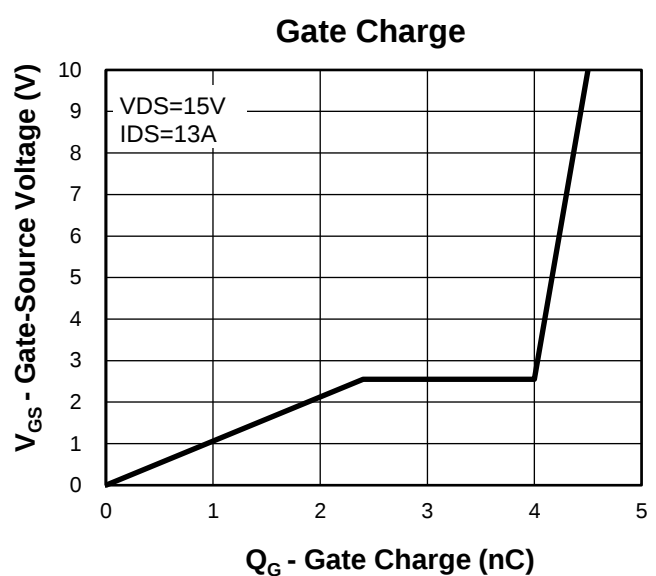
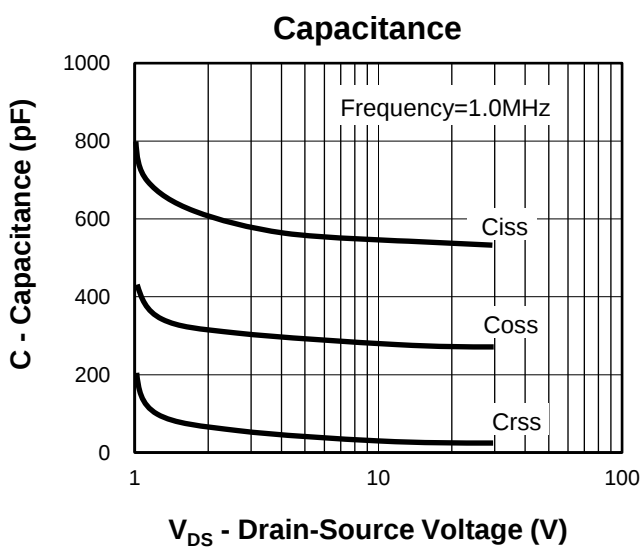
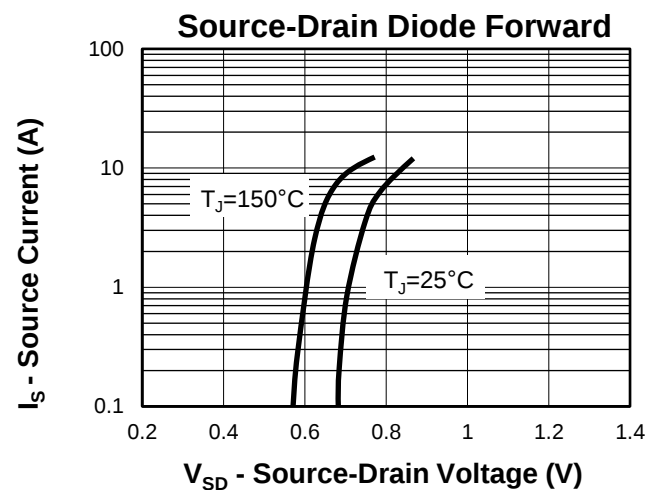
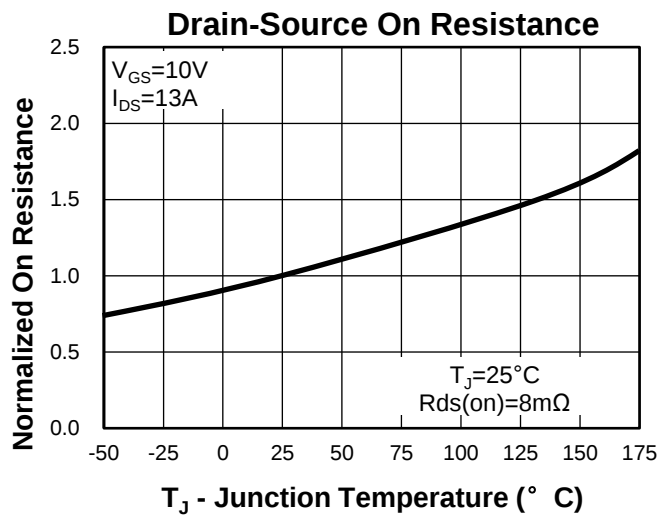
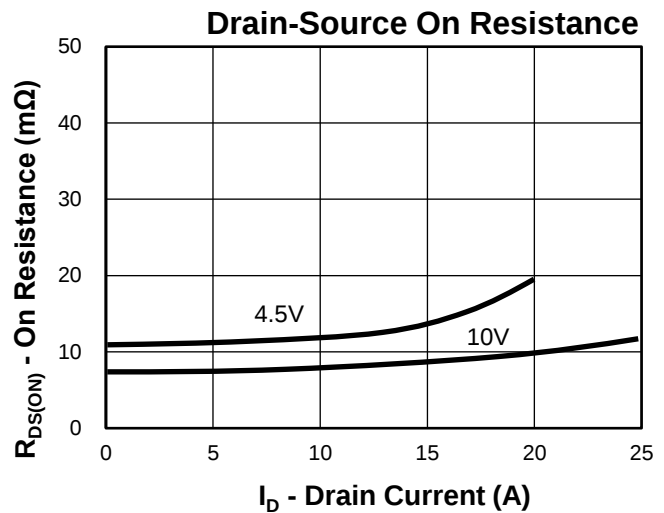
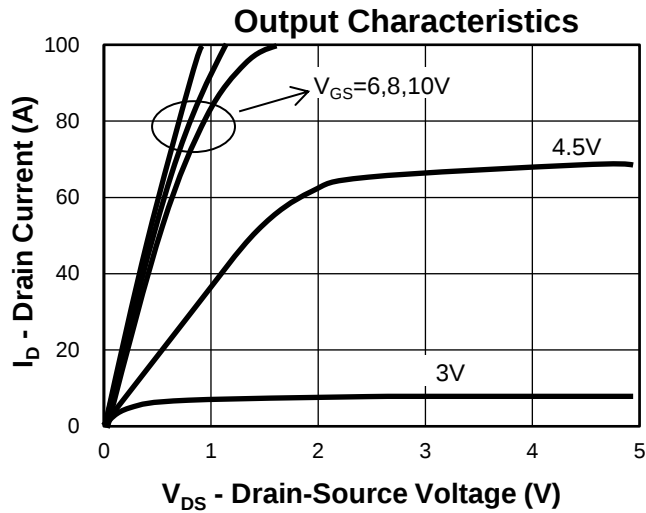


1st Line: Kwansemi Code(KS)
2nd Line: Part Number(3428T)
3rd Line: Lot Number(YWWXXX)

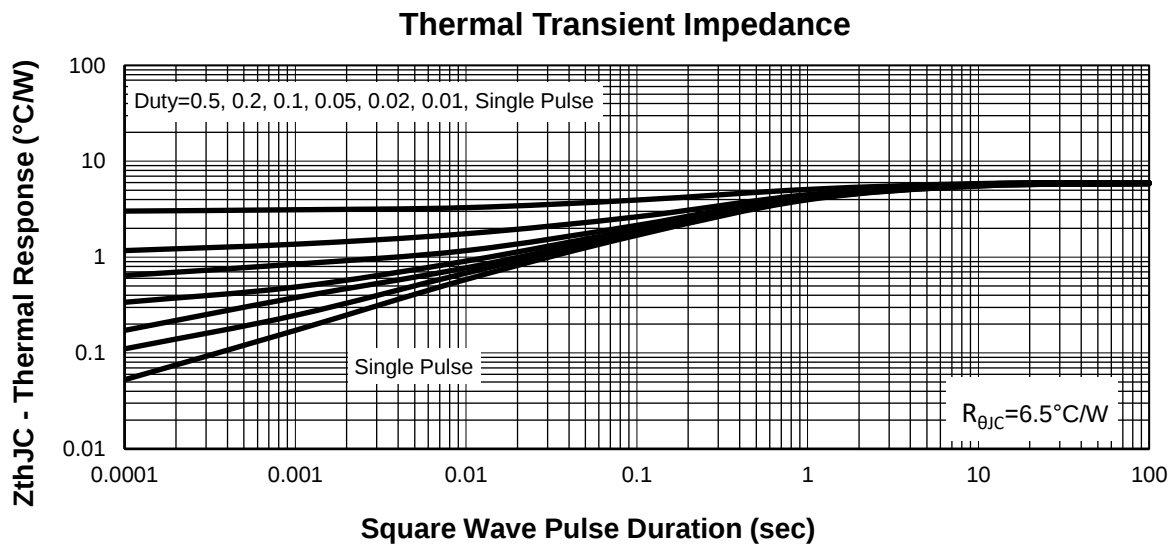
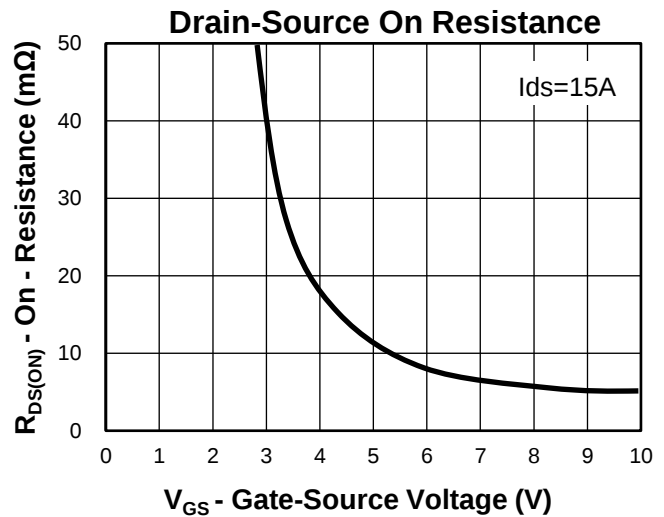
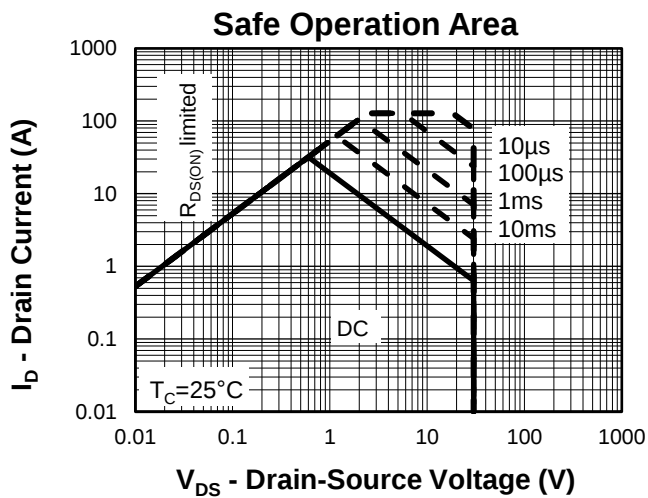
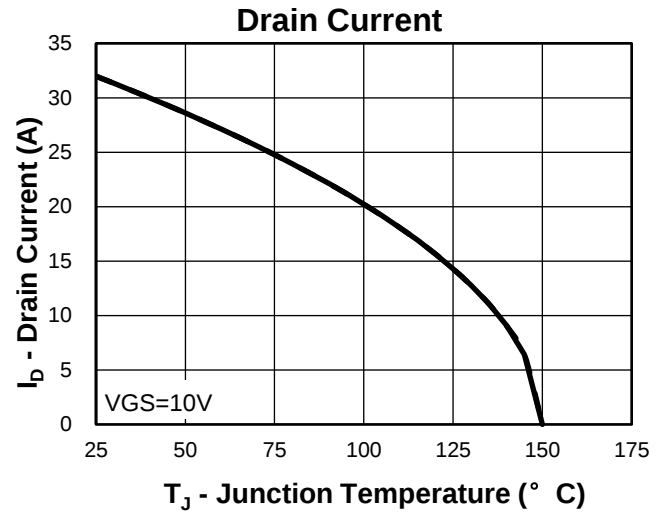
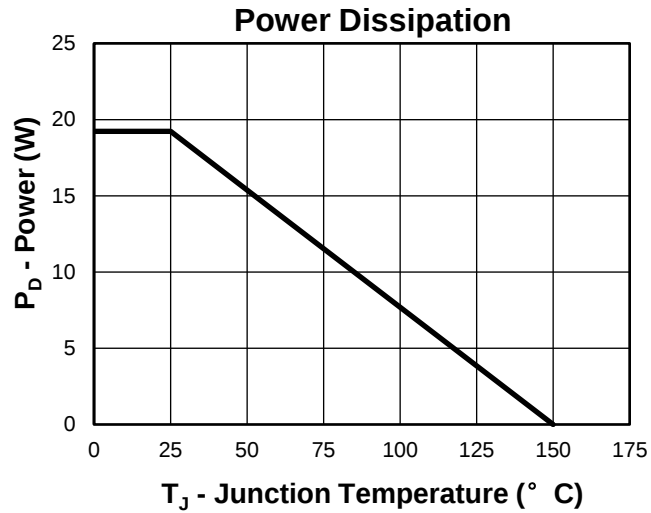
Typical Characteristics(Q1-Channel)



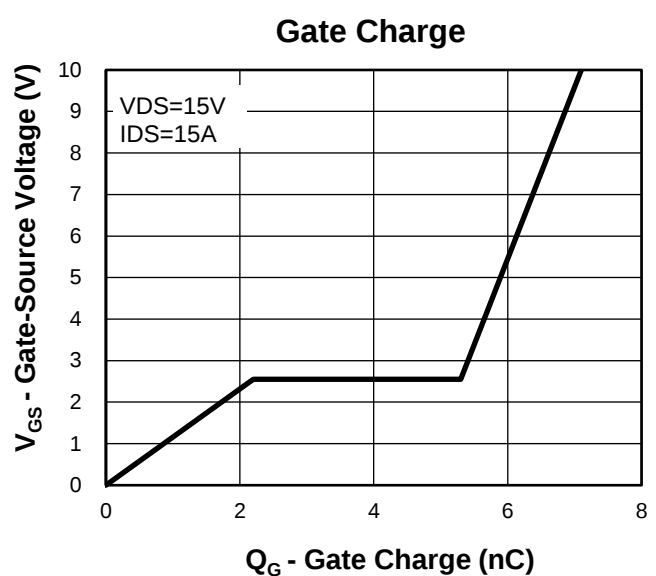
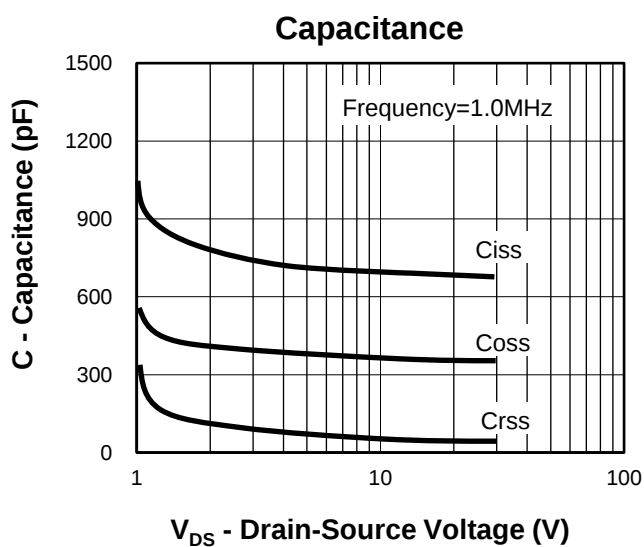
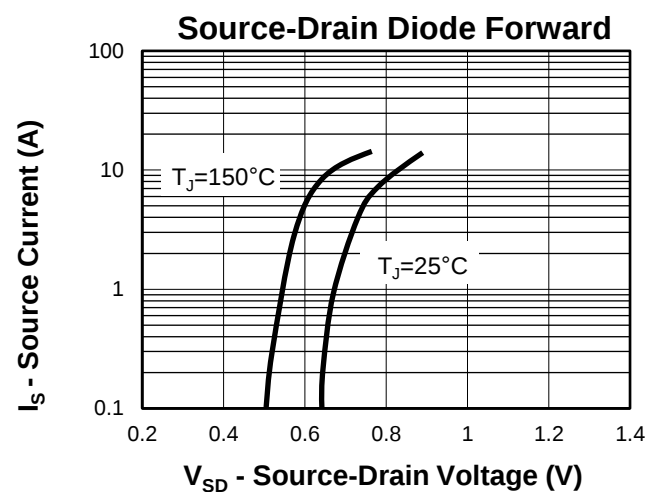
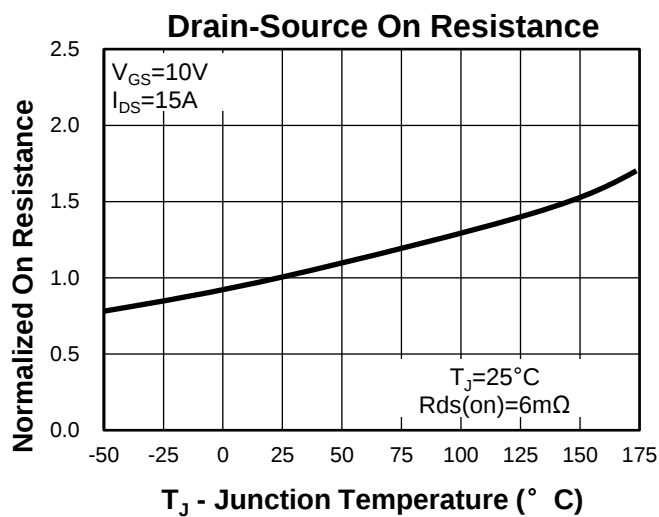
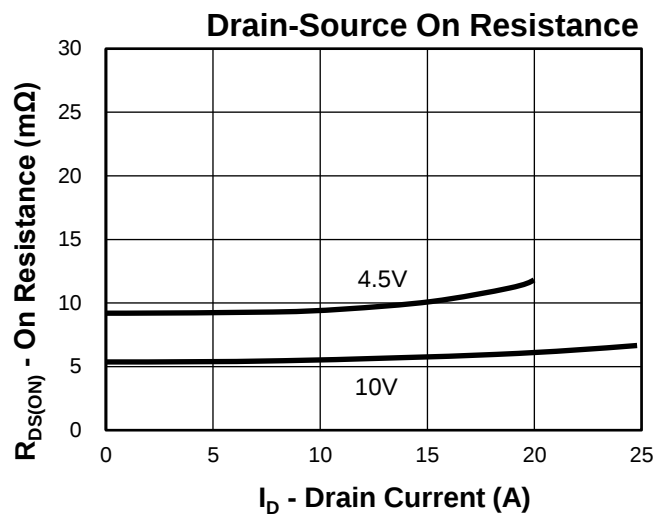
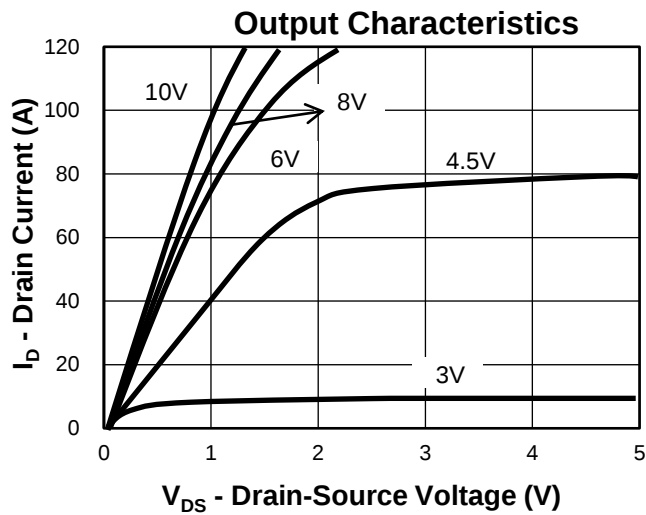
Typical Characteristics(Q1-Channel)



Typical Characteristics(Q2-Channel)

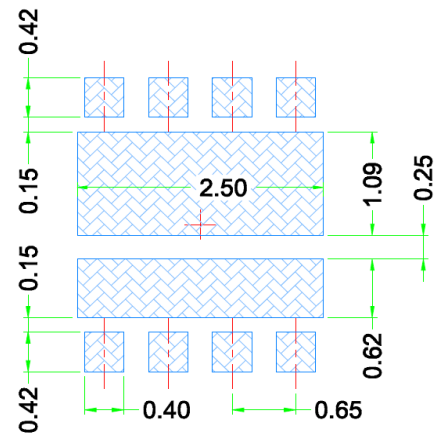
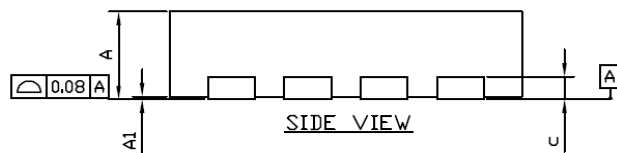
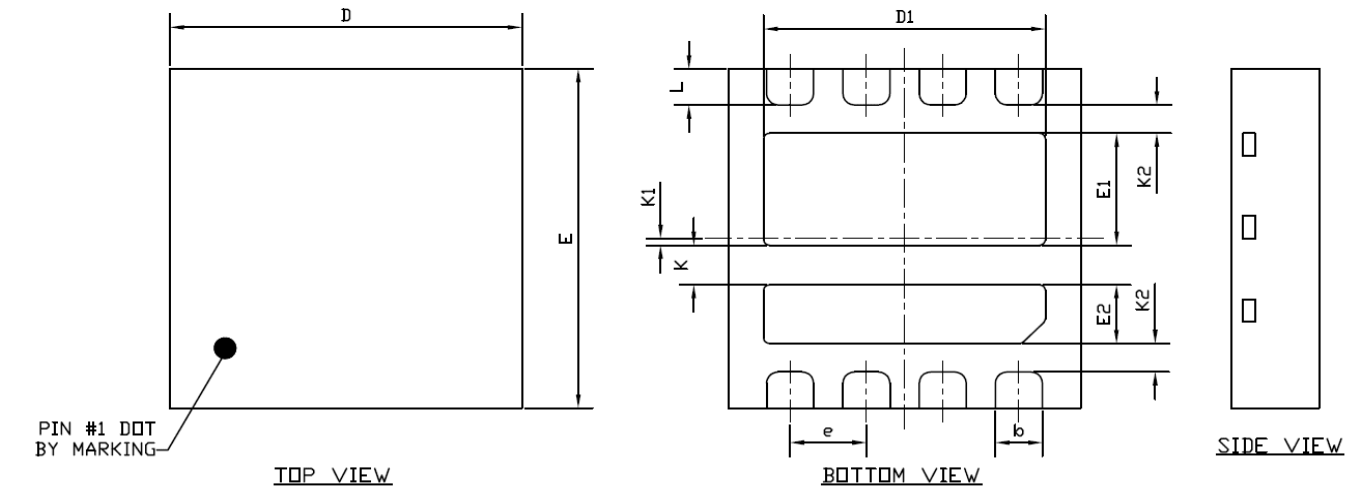


Typical Characteristics(Q2-Channel)



Package Information

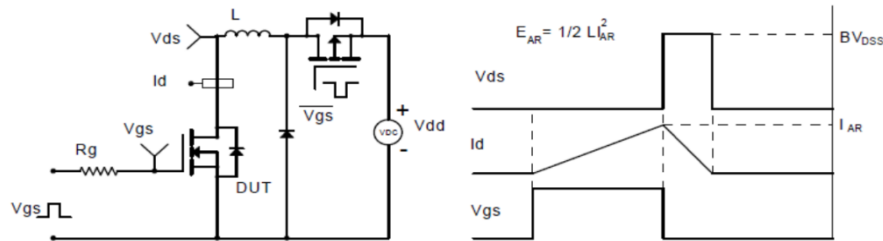
SDFN3030 DP2



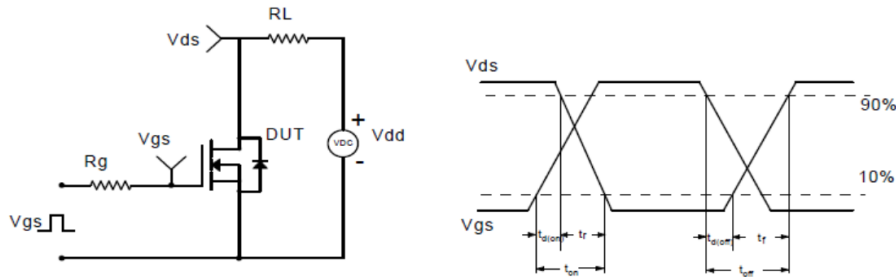
Land Pattern
(Only for Reference)

SYMBOL	MM			INCH		
	MIN	NOM	MAX	MIN	NOM	MAX
A	0.70	0.75	0.80	0.028	0.030	0.031
A1	0.00		0.05	0.000		0.002
b	0.35	0.40	0.45	0.014	0.016	0.018
c	0.20 REF.			0.008 REF.		
D	2.90	3.00	3.10	0.114	0.118	0.122
D1	2.30	2.40	2.50	0.091	0.094	0.098
E	2.90	3.00	3.10	0.114	0.118	0.122
E1	0.89	0.99	1.09	0.035	0.039	0.043
E2	0.42	0.52	0.62	0.017	0.020	0.024
e	0.65 BSC			0.026 BSC		
L	0.27	0.32	0.35	0.011	0.013	0.014
K	0.35 REF.			0.014 REF.		
K1	0.06 REF.			0.002 REF.		
K2	0.25 REF.			0.010 REF.		

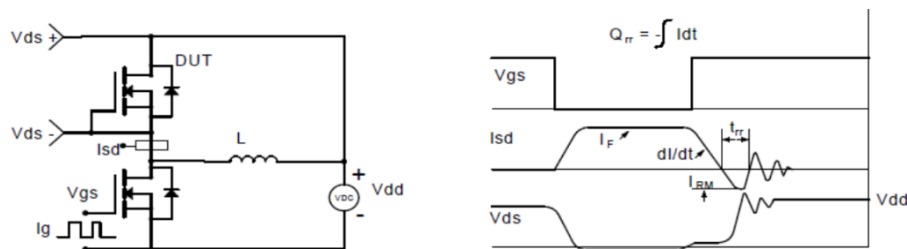
Avalanche Test Circuit and Waveforms



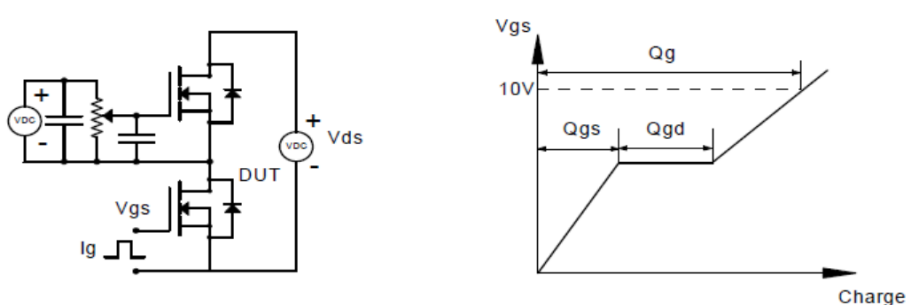
Switching Time Test Circuit and Waveforms



Diode Recovery Test Circuit and Waveforms



Gate Charge Test Circuit and Waveform



Customer Service

Kwansemi Semiconductor Co.,Ltd

Email:Sales@kwansemi.com

Web:www.kwansemi.com

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